

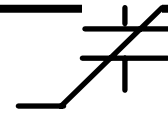
Static FRAM: A Novel Ferroelectric Memory

Joseph T. Evans, Jr.

Presented by Michelle Bell

Radiant Technologies, Inc.

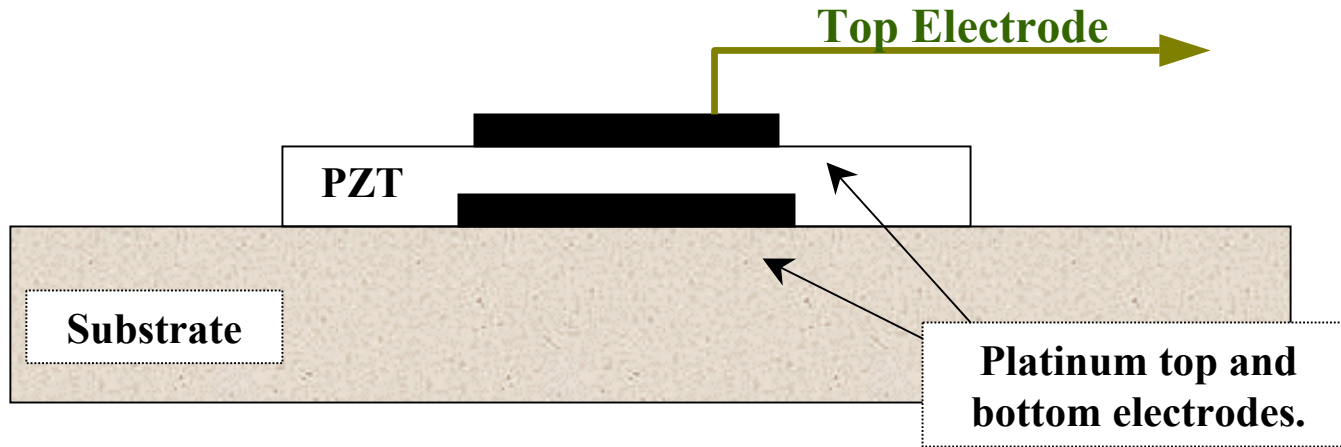
November 5, 2002



Summary

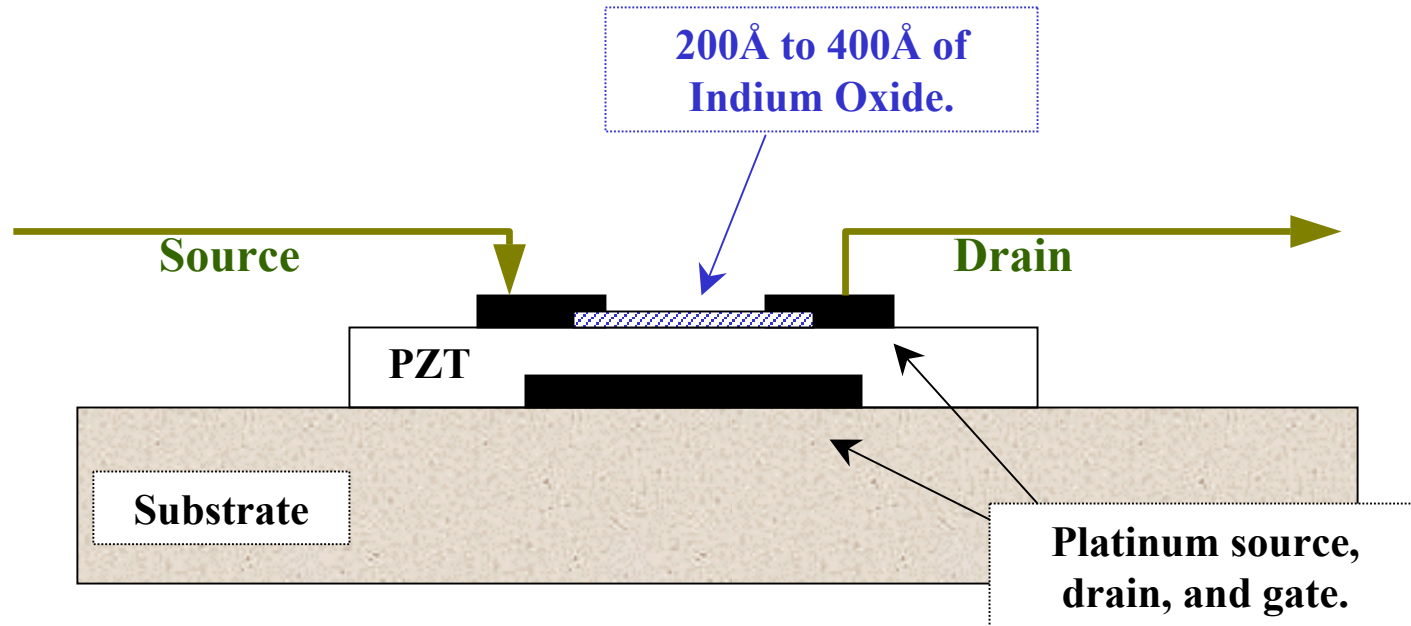
- There are efforts today to make non-volatile transistors by inserting a ferroelectric film into the gate of a MOSFET.
- It is much simpler to build Thin Film Transistors (TFTs) using thin ferroelectric films as the gate material and semiconducting oxides as the channel.
- Radiant has built and tested such devices.
- This presentation will disclose the device structure, operation, and application to memories.

Standard Capacitor Cross Section



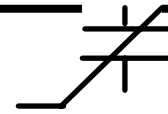
- A simple ferroelectric capacitor has a thin ferroelectric film sandwiched between two electrodes.
- The substrate is usually silicon but can be anything that can take the temperature.
- Radiant has built capacitors on stainless steel!

Transistor Cross Section



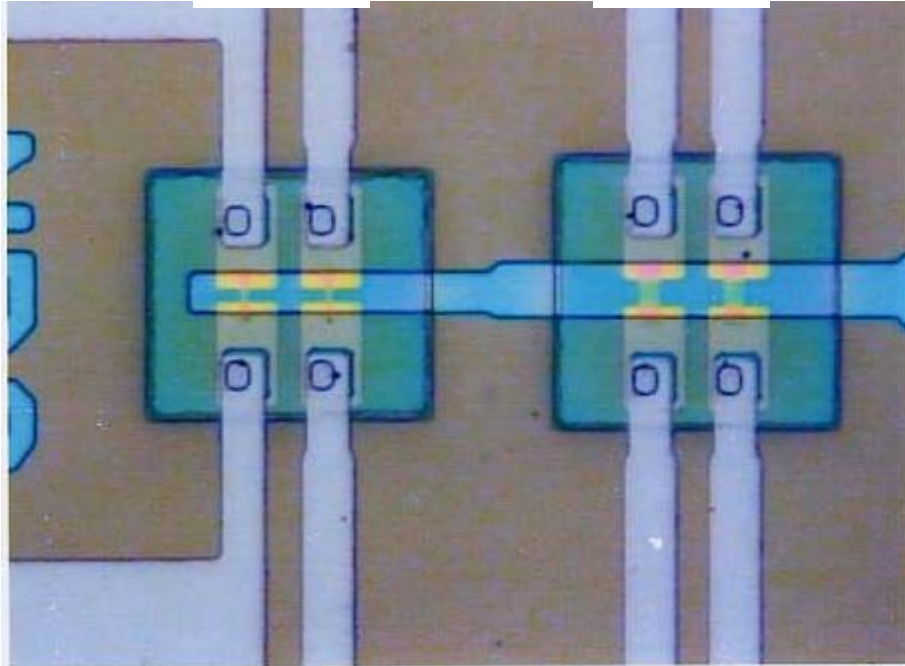
- The TFFT (Thin Ferroelectric Film Transistor) is a ferroelectric capacitor where the top electrode is replaced by a conducting oxide. -->> **Simple!** <<--

Photo Op!



2 μ x 2 μ

5 μ x 5 μ

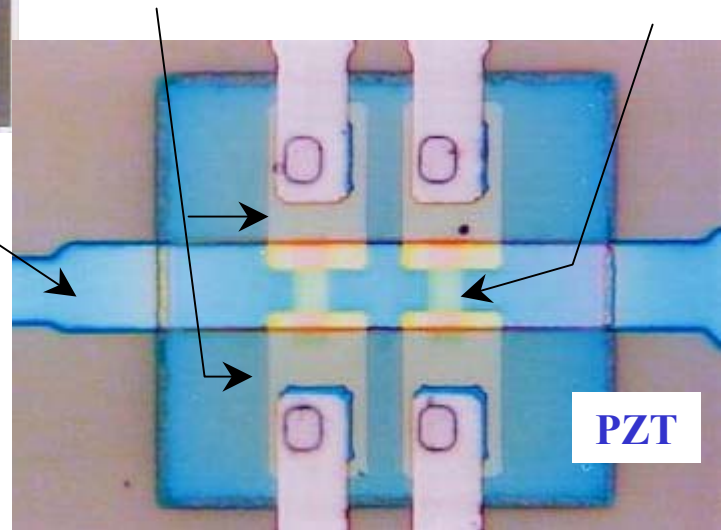


3500Å of 20/80 PZT
with 200Å of Indium
Oxide semiconductor.

Pt Source
and Drain

Semiconducting
Oxide

Gate
(Bottom Electrode)

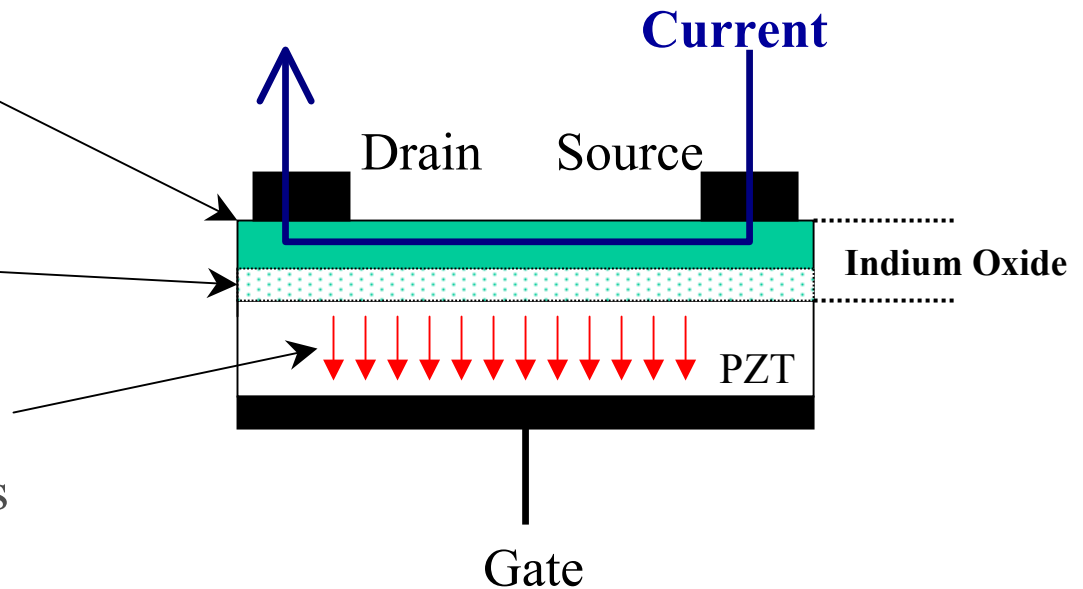


The transistors are fully
integrated with passivation
and metal interconnect.

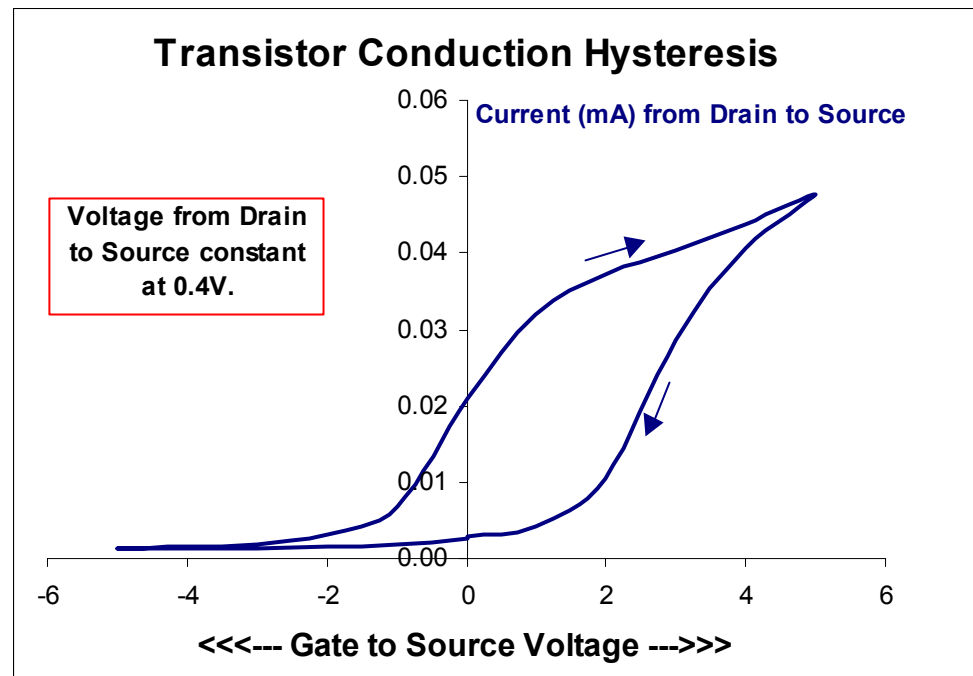
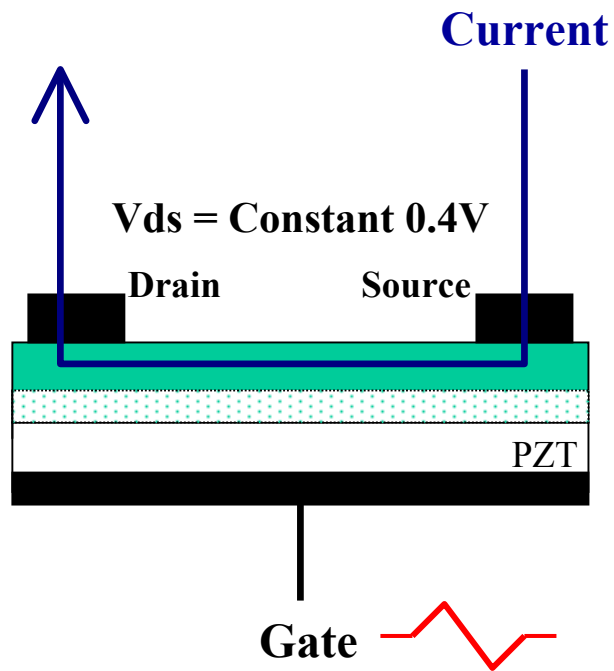
Theory of Operation

The TFFT is a JFET, not a MOSFET!

- Conductive Region of Indium Oxide.
- Non-conductive region of Indium Oxide. (Depletion Region)
- The non-conductive region grows or shrinks according to the polarization!

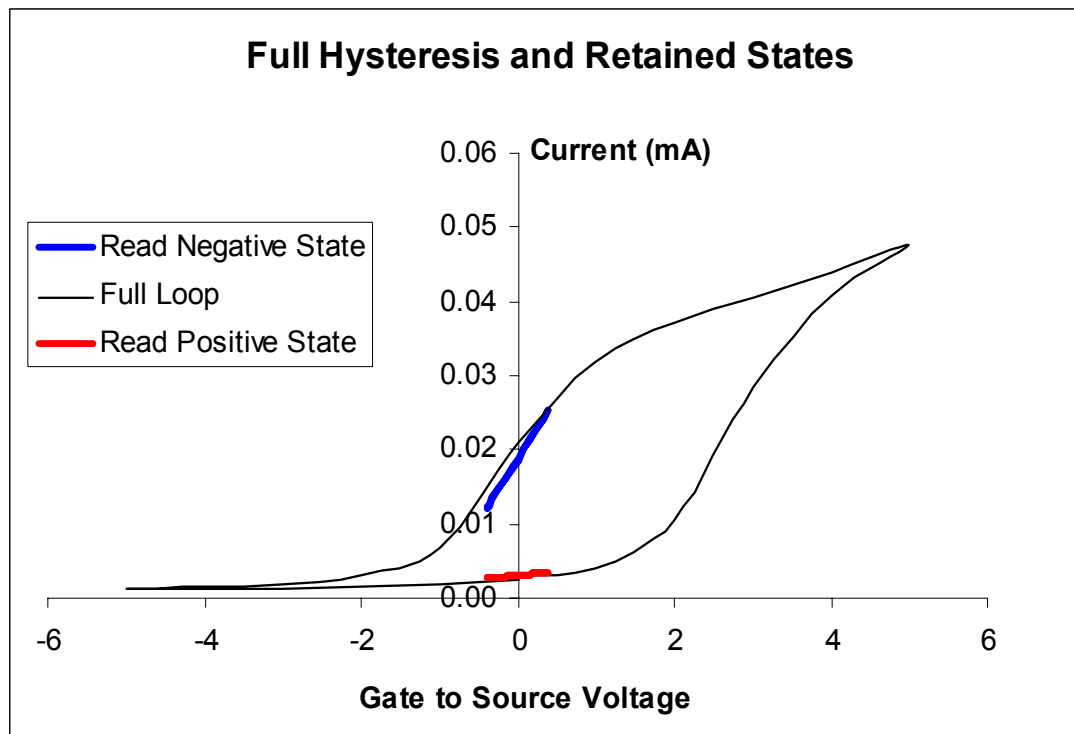


Transistor Hysteresis

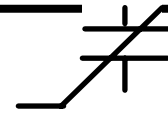


- The TF-FET hysteresis is centered on zero gate volts, giving it current memory.

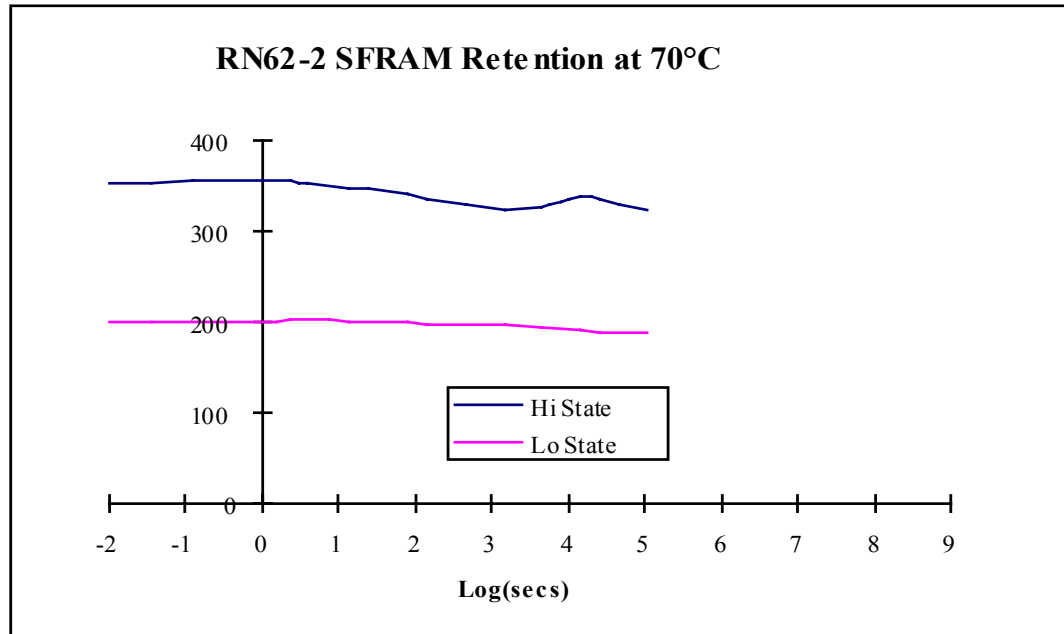
Memory Effect



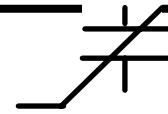
- Reads executed at 0.4V do not disturb states written at $\pm 5V$.



Retention at 70°C

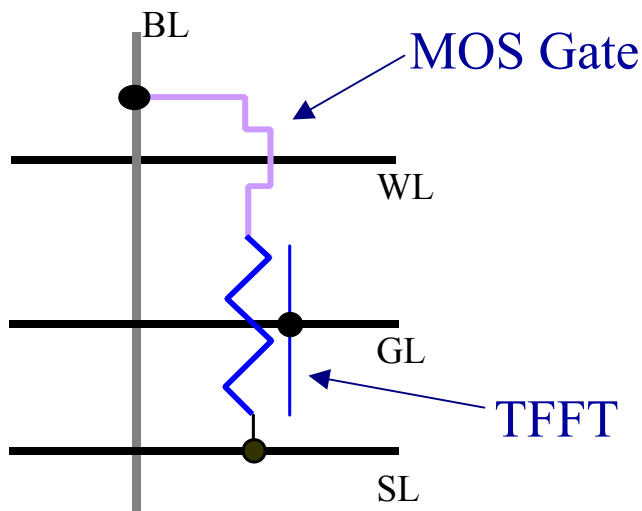


- TFFTs also show no fatigue and no imprint.

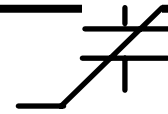


Memory Cell

The memory cell has a pass transistor and four control lines. The pass gate is required to prevent disturbs.

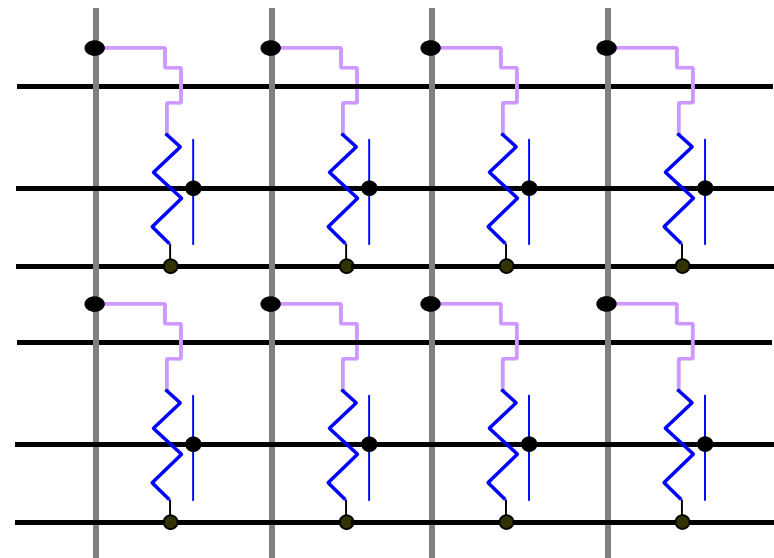


Cell areas approaching $6\mu^2$ are possible with 0.5u CMOS technology.



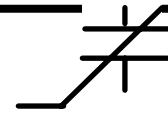
TFFT Memories -> SFRAM

- SFRAM memories operate totally asynchronously with 100% SRAM control line compatibility.
 - Chip select can be tied low and reads can ripple through.
 - 2x faster than FRAM
 - Extremely low power consumption during read operations.
 - Smaller cell.



Radiant Technologies, Inc.

Conclusion



- A Thin Film Transistor (TFT) can be fabricated by placing a semiconducting oxide channel on top of a thin ferroelectric film capacitor.
- The transistors have excellent characteristics and are easier to fabricate than MFSFETs (Metal Ferroelectric Semiconductor Field Effect Transistors).
- Memories fabricated with the TFTs can exceed existing FRAMs in density and speed.
- The most important aspect of the SFRAM is the incredibly low power at which they can be operated.